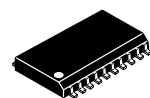


Octal 3-State Buffer, Inverting/Non-Inverting

MM74HCT540, MM74HCT541



SOIC-20 WB
CASE 751D-05

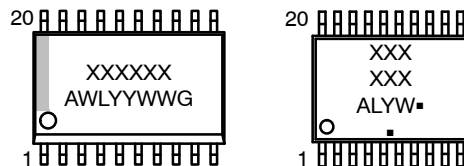


TSSOP-20 WB
CASE 948E



TSSOP-20
CASE 948AQ

MARKING DIAGRAMS



XXXXX = Specific Device Code
A = Assembly Location
L/WL = Wafer Lot
YY = Year
YW/WW = Work Week
▪ or G = Pb-Free Package

(Note: Microdot may be in either location)

General Description

The MM74HCT540 and MM74HCT541 3-STATE buffers utilize advanced silicon-gate CMOS technology and are general purpose high speed inverting and non-inverting buffers. They possess high drive current outputs which enable high speed operation even when driving large bus capacitances. These circuits achieve speeds comparable to low power Schottky devices, while retaining the low power consumption of CMOS. Both devices are TTL input compatible and have a fanout of 15 LS-TTL equivalent inputs.

MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug-in replacements for LS-TTL devices and can be used to reduce power consumption in existing designs.

The MM74HCT540 is an inverting buffer and the MM74HCT541 is a non-inverting buffer. The 3-STATE control gate operates as a two-input NOR such that if either $\overline{G1}$ or $\overline{G2}$ are HIGH, all eight outputs are in the high-impedance state.

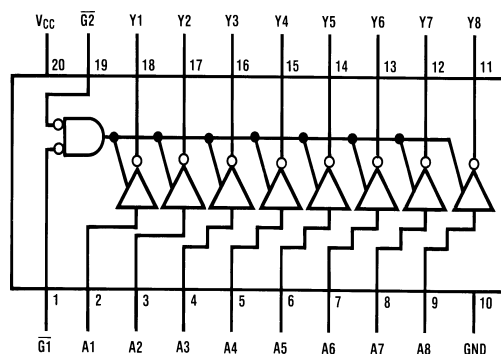
In order to enhance PC board layout, the MM74HCT540 and MM74HCT541 offers a pinout having inputs and outputs on opposite sides of the package. All inputs are protected from damage due to static discharge by diodes to V_{CC} and ground.

Features

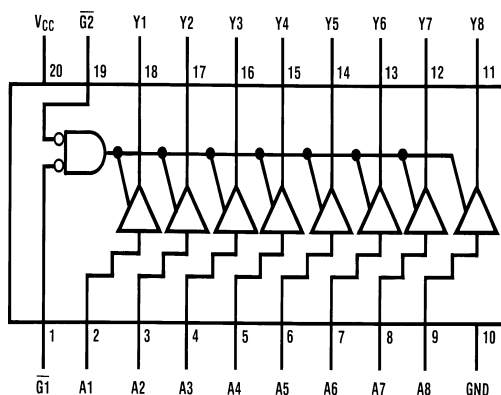
- TTL Input Compatible
- Typical Propagation Delay: 12 ns
- 3-STATE Outputs for Connection to System Buses
- Low Quiescent Current: 160 μ A
- Output Current: 6 mA (min)
- These are Pb-Free Devices

CONNECTION DIAGRAMS

Pin Assignment for SOIC and TSSOP



MM74HCT540 (Top View)



MM74HCT541 (Top View)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

MM74HCT540, MM74HCT541

ABSOLUTE MAXIMUM RATINGS (Note 1)

| Symbol | Parameter | Value | Unit |
|-----------------------------------|--|-------------------------------|------|
| V _{CC} | Supply Voltage | -0.5 to +7.0 | V |
| V _{IN} | DC Input Voltage | -0.5 to V _{CC} + 0.5 | V |
| V _{OUT} | DC Output Voltage | -0.5 to V _{CC} + 0.5 | V |
| I _{IK} , I _{OK} | Clamp Diode Current | ±20 | mA |
| I _{OUT} | DC Output Current, per Pin | ±35 | mA |
| I _{CC} | DC V _{CC} or GND Current, per Pin | ±70 | mA |
| T _{STG} | Storage Temperature Range | -65 to +150 | °C |
| P _D | Power Dissipation S. O. Package Only | 500 | mW |
| T _L | Lead Temperature (Soldering 10 seconds) | 260 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Unless otherwise specified all voltages are referenced to ground.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit |
|------------------------------------|-----------------------------|-----|-----------------|------|
| V _{CC} | Supply Voltage | 4.5 | 5.5 | V |
| V _{IN} , V _{OUT} | DC Input or Output Voltage | 0 | V _{CC} | V |
| T _A | Operating Temperature Range | -55 | +125 | °C |
| t _r , t _f | Input Rise or Fall Times | - | 500 | ns |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS (V_{CC} = 5 V ±10% unless otherwise specified)

| Symbol | Parameter | Conditions | T _A = 25°C | | T _A = -40°C to 85°C | T _A = -55°C to 125°C | Unit |
|-----------------|--|---|-------------------------------|--------------------------------------|--------------------------------------|------------------------------------|------|
| | | | Typ | Guaranteed Limits | | | |
| V _{IH} | Minimum HIGH Level Input Voltage | | - | 2.0 | 2.0 | 2.0 | V |
| V _{IL} | Maximum LOW Level Input Voltage | | - | 0.8 | 0.8 | 0.8 | V |
| V _{OH} | Minimum HIGH Level Output Voltage | V _{IN} = V _{IH} or V _{IL} I _{OUT} = 20 μA I _{OUT} = 6.0 mA, V _{CC} = 4.5 V I _{OUT} = 7.2 mA, V _{CC} = 5.5 V | V _{CC} 4.2 5.2 | V _{CC} -0.1 3.98 4.98 | V _{CC} -0.1 3.84 4.84 | V _{CC} -0.1 3.7 4.7 | V |
| V _{OL} | Maximum LOW Level Voltage | V _{IN} = V _{IH} or V _{IL} I _{OUT} = 20 μA I _{OUT} = 6.0 mA, V _{CC} = 4.5 V I _{OUT} = 7.2 mA, V _{CC} = 5.5 V | 0 0.2 0.2 | 0.1 0.26 0.26 | 0.1 0.33 0.33 | 0.1 0.4 0.4 | V |
| I _{IN} | Maximum Input Current | V _{IN} = V _{CC} or GND | - | ±0.1 | ±1.0 | ±1.0 | μA |
| I _{OZ} | Maximum 3-STATE Output Leakage Current | V _{OUT} = V _{CC} or GND G̅ = V _{IH} | - | ±0.5 | ±5.0 | ±10 | μA |
| I _{CC} | Maximum Quiescent Supply Current | V _{IN} = V _{CC} or GND I _{OUT} = 0 μA | - | 8.0 | 80 | 160 | μA |
| | | V _{IN} = 2.4 V or 0.5 V (Note 2) | 0.6 | 1.0 | 1.3 | 1.5 | mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Measured per input. All other inputs at V_{CC} or GND.

MM74HCT540, MM74HCT541

AC ELECTRICAL CHARACTERISTICS

(MM74HCT540: $V_{CC} = 5.0\text{ V}$, $t_r = t_f = 6\text{ ns}$, $T_A = 25^\circ\text{C}$, unless otherwise specified)

| Symbol | Parameter | Conditions | Typ | Guaranteed Limit | Unit |
|-----------------------|----------------------------------|---|-----|------------------|------|
| t_{PHL} , t_{PLH} | Maximum Output Propagation Delay | $C_L = 45\text{ pF}$ | 12 | 18 | ns |
| t_{PZL} , t_{PZH} | Maximum Output Enable Time | $C_L = 45\text{ pF}$, $R_L = 1\text{ k}\Omega$ | 14 | 28 | ns |
| t_{PLZ} , t_{PHZ} | Maximum Output Disable Time | $C_L = 5\text{ pF}$, $R_L = 1\text{ k}\Omega$ | 13 | 25 | ns |

AC ELECTRICAL CHARACTERISTICS

(MM74HCT540: $V_{CC} = 5.0\text{ V} \pm 10\%$, $t_r = t_f = 6\text{ ns}$, unless otherwise specified)

| Symbol | Parameter | Conditions | $T_A = 25^\circ\text{C}$ | | $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ | $T_A = -55^\circ\text{C to } 125^\circ\text{C}$ | Unit |
|-----------------------|--|--|--------------------------|-------------------|--|---|------|
| | | | Typ | Guaranteed Limits | | | |
| t_{PHL} , t_{PLH} | Maximum Output Propagation Delay | $C_L = 50\text{ pF}$ | 12 | 20 | 25 | 30 | ns |
| | | $C_L = 150\text{ pF}$ | 22 | 30 | 38 | 45 | |
| t_{PZH} , t_{PZL} | Maximum Output Enable Time | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ | 15 | 30 | 38 | 45 | ns |
| | | $R_L = 1\text{ k}\Omega$, $C_L = 150\text{ pF}$ | 20 | 40 | 50 | 60 | ns |
| t_{PHZ} , t_{PLZ} | Maximum Output Disable Time | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ | 15 | 30 | 38 | 45 | ns |
| t_{THL} , t_{TLH} | Maximum Output Rise and Fall Time | $C_L = 50\text{ pF}$ | 6 | 12 | 15 | 18 | ns |
| C_{IN} | Maximum Input Capacitance | | 5 | 10 | 10 | 10 | pF |
| C_{OUT} | Maximum Output Capacitance | | 15 | 20 | 20 | 20 | pF |
| C_{PD} | Power Dissipation Capacitance (Note 3) | (per output) $\bar{G} = V_{CC}$ | 12 | – | – | – | pF |
| | | $\bar{G} = \text{GND}$ | 50 | – | – | – | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

MM74HCT540, MM74HCT541

AC ELECTRICAL CHARACTERISTICS

(MM74HCT541: $V_{CC} = 5.0\text{ V}$, $t_r = t_f = 6\text{ ns}$, $T_A = 25^\circ\text{C}$, unless otherwise specified)

| Symbol | Parameter | Conditions | Typ | Guaranteed Limit | Unit |
|-----------------------|----------------------------------|---|-----|------------------|------|
| t_{PHL} , t_{PLH} | Maximum Output Propagation Delay | $C_L = 45\text{ pF}$ | 13 | 20 | ns |
| t_{PZL} , t_{PZH} | Maximum Output Enable Time | $C_L = 45\text{ pF}$, $R_L = 1\text{ k}\Omega$ | 17 | 28 | ns |
| t_{PLZ} , t_{PHZ} | Maximum Output Disable Time | $C_L = 5\text{ pF}$, $R_L = 1\text{ k}\Omega$ | 15 | 25 | ns |

AC ELECTRICAL CHARACTERISTICS

(MM74HCT541: $V_{CC} = 5.0\text{ V} \pm 10\%$, $t_r = t_f = 6\text{ ns}$, unless otherwise specified)

| Symbol | Parameter | Conditions | $T_A = 25^\circ\text{C}$ | | $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ | $T_A = -55^\circ\text{C to } 125^\circ\text{C}$ | Unit |
|-----------------------|--|--|--------------------------|-------------------|--|---|------|
| | | | Typ | Guaranteed Limits | | | |
| t_{PHL} , t_{PLH} | Maximum Output Propagation Delay | $C_L = 50\text{ pF}$ | 14 | 23 | 29 | 34 | ns |
| | | $C_L = 150\text{ pF}$ | 17 | 33 | 42 | 49 | |
| t_{PZH} , t_{PZL} | Maximum Output Enable Time | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ | 17 | 30 | 38 | 45 | ns |
| | | $R_L = 1\text{ k}\Omega$, $C_L = 150\text{ pF}$ | 22 | 40 | 50 | 60 | ns |
| t_{PHZ} , t_{PLZ} | Maximum Output Disable Time | $R_L = 1\text{ k}\Omega$, $C_L = 50\text{ pF}$ | 17 | 30 | 38 | 45 | ns |
| t_{THL} , t_{TLH} | Maximum Output Rise and Fall Time | $C_L = 50\text{ pF}$ | 6 | 12 | 15 | 18 | ns |
| C_{IN} | Maximum Input Capacitance | | 5 | 10 | 10 | 10 | pF |
| C_{OUT} | Maximum Output Capacitance | | 15 | 20 | 20 | 20 | pF |
| C_{PD} | Power Dissipation Capacitance (Note 4) | (per output) $\bar{G} = V_{CC}$ | 12 | – | – | – | pF |
| | | $\bar{G} = \text{GND}$ | 45 | – | – | – | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

MM74HCT540, MM74HCT541

ORDERING INFORMATION

| Device | Package | Shipping† |
|----------------|--------------------|--------------------------|
| MM74HCT540MTCX | TSSOP-20 (Pb-Free) | 2500 Units / Tape & Reel |
| MM74HCT541WM | SOIC-20 (Pb-Free) | 38 Units / Tube |
| MM74HCT541MTCX | TSSOP-20 (Pb-Free) | 2500 Units / Tape & Reel |
| MM74HCT541MTC | TSSOP-20 (Pb-Free) | 75 Units / Tube |
| MM74HCT541WMX | SOIC-20 (Pb-Free) | 1000 Units / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



SCALE 1:1

SOIC-20 WB
CASE 751D-05
ISSUE H

DATE 22 APR 2015



NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS | |
|-----|-------------|-------|
| | MIN | MAX |
| A | 2.35 | 2.65 |
| A1 | 0.10 | 0.25 |
| b | 0.35 | 0.49 |
| c | 0.23 | 0.32 |
| D | 12.65 | 12.95 |
| E | 7.40 | 7.60 |
| e | 1.27 BSC | |
| H | 10.05 | 10.55 |
| h | 0.25 | 0.75 |
| L | 0.50 | 0.90 |
| θ | 0° | 7° |

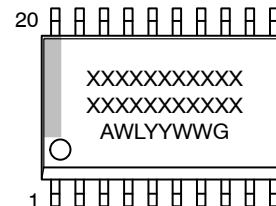
RECOMMENDED
SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC
MARKING DIAGRAM*



- XXXXXX = Specific Device Code
- A = Assembly Location
- WL = Wafer Lot
- YY = Year
- WW = Work Week
- G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

| | | |
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MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

ON Semiconductor®



TSSOP-20 WB
CASE 948E
ISSUE D

DATE 17 FEB 2016

SCALE 2:1

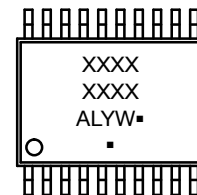


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| | MIN | MAX | MIN | MAX |
| A | 6.40 | 6.60 | 0.252 | 0.260 |
| B | 4.30 | 4.50 | 0.169 | 0.177 |
| C | --- | 1.20 | --- | 0.047 |
| D | 0.05 | 0.15 | 0.002 | 0.006 |
| F | 0.50 | 0.75 | 0.020 | 0.030 |
| G | 0.65 BSC | | 0.026 BSC | |
| H | 0.27 | 0.37 | 0.011 | 0.015 |
| J | 0.09 | 0.20 | 0.004 | 0.008 |
| J1 | 0.09 | 0.16 | 0.004 | 0.006 |
| K | 0.19 | 0.30 | 0.007 | 0.012 |
| K1 | 0.19 | 0.25 | 0.007 | 0.010 |
| L | 6.40 BSC | | 0.252 BSC | |
| M | 0° | 8° | 0° | 8° |

GENERIC MARKING DIAGRAM*



- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

| | | |
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MECHANICAL CASE OUTLINE

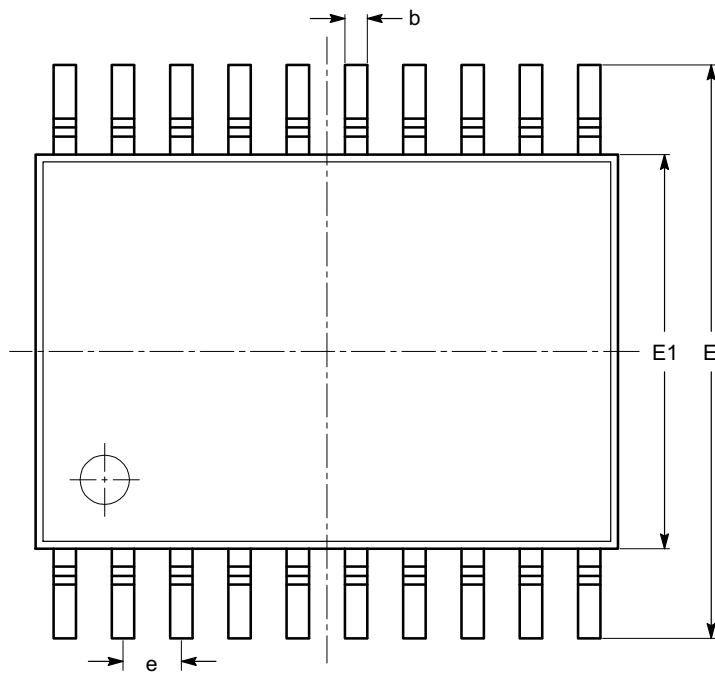
PACKAGE DIMENSIONS

ON Semiconductor®



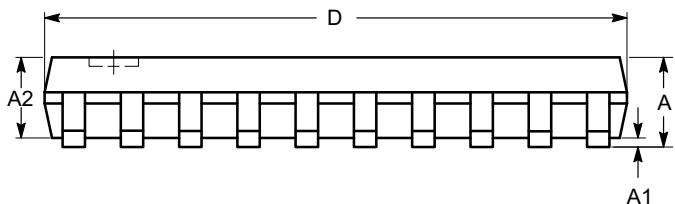
TSSOP20, 4.4x6.5
CASE 948AQ-01
ISSUE A

DATE 19 MAR 2009

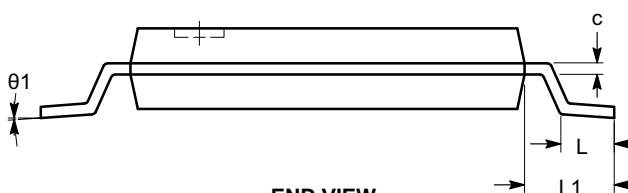


| SYMBOL | MIN | NOM | MAX |
|----------|----------|------|------|
| A | | | 1.20 |
| A1 | 0.05 | | 0.15 |
| A2 | 0.80 | | 1.05 |
| b | 0.19 | | 0.30 |
| c | 0.09 | | 0.20 |
| D | 6.40 | 6.50 | 6.60 |
| E | 6.30 | 6.40 | 6.50 |
| E1 | 4.30 | 4.40 | 4.50 |
| e | 0.65 BSC | | |
| L | 0.45 | 0.60 | 0.75 |
| L1 | 1.00 REF | | |
| θ | 0° | | 8° |

TOP VIEW



SIDE VIEW



END VIEW

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-153.

| | | |
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| DESCRIPTION: | TSSOP20, 4.4X6.5 | PAGE 1 OF 1 |

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